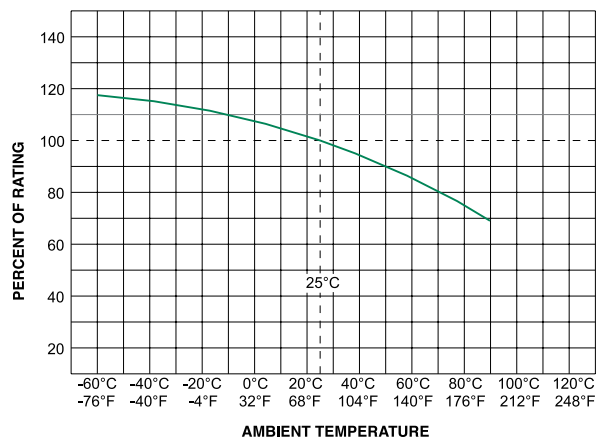
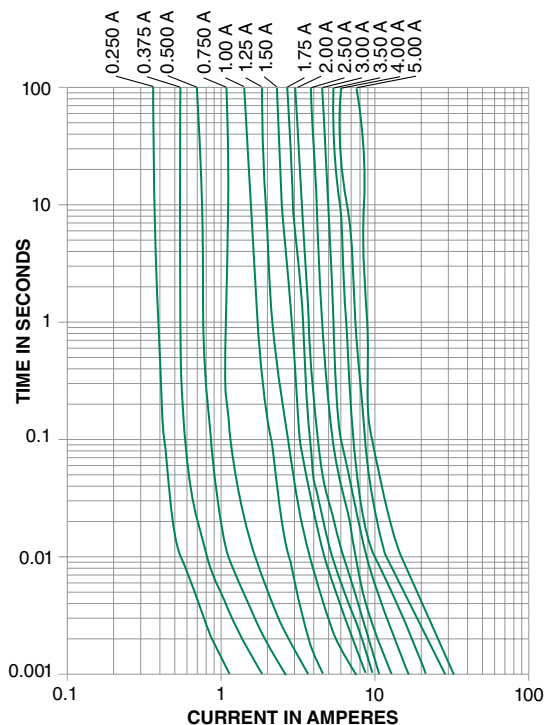


Temperature Derating Curve

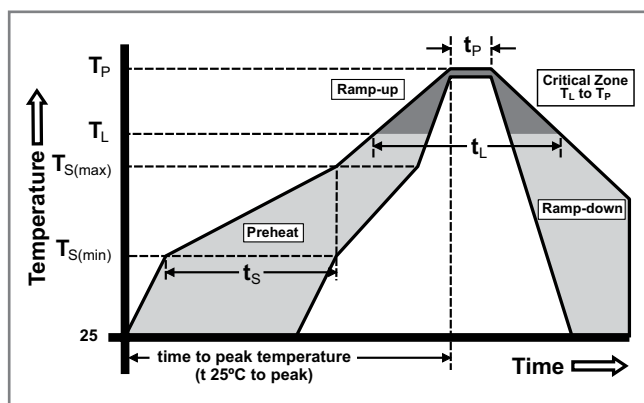


Average Time Current Curves



Soldering Parameters

Reflow Condition		Pb – free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (Min to Max) (t_s)	60 – 180 seconds
Average Ramp-up Rate (Liquidus Temp (T_L) to peak)		5°C/second max.
$T_{s(max)}$ to T_L - Ramp-up Rate		5°C/second max.
Reflow	- Temperature (T_L) (Liquidus)	217°C
	- Temperature (t_L)	60 – 150 seconds
Peak Temperature (T_p)		250 ^{+0/-5} °C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		5°C/second max.
Time 25°C to peak Temperature (T_p)		8 minutes max.
Do not exceed		260°C



Surface Mount Fuses

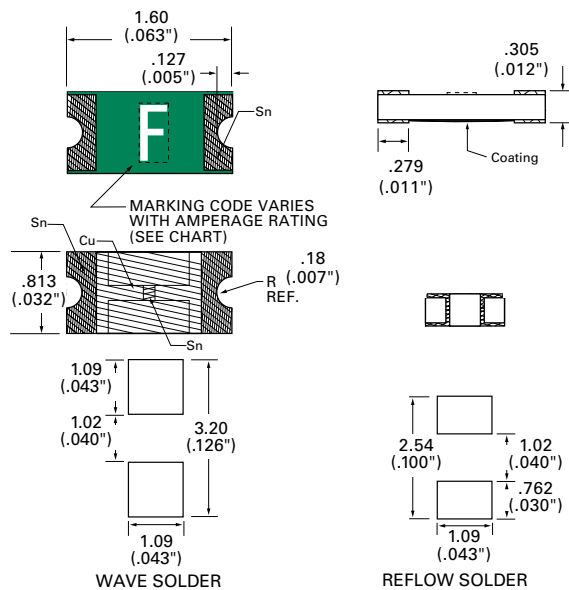
Thin Film > 0603 Size > Fast-Acting > 494 Series

Product Characteristics

Materials	Body: Advanced High Temperature Substrate Terminations: 100% Tin over Nickel over Copper Element Cover Coat: Conformal Coating
Operating Temperature	- 55°C to 90°C. Consult temperature derating curve chart. For operation above 90°C contact Littelfuse.
Humidity	MIL-STD-202F, Method 103B, Condition D

Thermal Shock	Withstands 5 cycles of - 55°C to 125°C
Vibration	Per MIL-STD-202F
Insulation Resistance (After Opening)	Greater than 10,000 ohms
Resistance to Soldering Heat	Withstands 60 seconds above 200°C and up to 260°C, maximum

Dimensions



Part Marking System

Amp Code	Marking Code
.250	D
.375	E
.500	F
.750	G
001.	H
1.25	J
01.4	III
01.5	K
1.75	L
002.	N
02.5	O
003.	P
3.15	III
03.5	R
004.	S
005.	T

Packaging

Packaging Option	Packaging Specification	Quantity	Quantity & Packaging Code
8mm Tape and Reel	EIA RS-481-2 (IEC 286, part 3)	5000	NR

Part Numbering System

0494002.NRHF

SERIES

AMP Code

Refer to Amp Code column in the Electrical Specifications table.
NOTE: The dot is positioned before the Packaging Suffix with whole ratings and within the numbering sequence for fractional ratings.

PACKAGING Code

NR = Tape and Reel, 5000 pcs

'HF' SUFFIX HALIDE FREE ITEM